



Ultrahigh-Speed Switching Applications

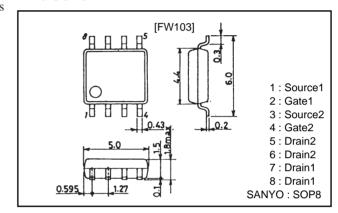
Features

- Low ON resistance
- Ultrahigh-speed switching.
- Composite type with two 4V-drive P-channel MOSFETs facilitating high-density mounting.
- Matched pair capability.

Package Dimensions

unit: mm

2129-SOP8



Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		-30	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		-3	Α
Drain Current (pulse)	IDP	PW≤10µs, duty cycle≤1%	-32	Α
Allowable Power Dissipation	PD	Mounted on a ceramic board (1000mm ² ×0.8mm) 1unit	1.7	W
Total Dissipation	PT	Mounted on a ceramic board (1000mm ² ×0.8mm)	2.0	W
Channel Temperature	Tch		150	°C
Storage temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
D-S Breakdown Voltage	V(BR)DSS	ID=-1mA, VGS=0	-30			V
Zero-Gate-Voltage Drain Current	IDSS	V _{DS} =-30V, V _{GS} =0			-100	μA
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =-10V, I _D =-1mA	-1.0		-2.5	V
Forward Transfer Admittance	ly _{fs}	V _{DS} =-10V, I _D =-3A	2	4		S
Static Drain-to-Source	R _{DS(on)}	I _D =-3A, V _G S=-10V		95	125	mΩ
ON-State Resistance	R _{DS(on)}	I _D =-3A, V _G S=-4V		150	205	mΩ
Input Capacitance	Ciss	V _{DS} =-10V, f=1MHz		550		pF
Output Capacitance	Coss	V _{DS} =-10V, f=1MHz		370		pF
Reverse Transfer Capacitance	Crss	V _{DS} =-10V, f=1MHz		70		pF

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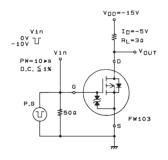
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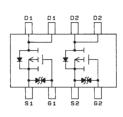
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Turn-ON Delay Time	td(on)	See specified Test Circuit.		20		ns
Rise Time	t _r	"		110		ns
Turn-OFF Delay Time	td(off)	"		330		ns
Fall Time	tf	"		170		ns
Diode Forward Voltage	V _{SD}	I _S =-3A, V _{GS} =0		-1.0	-1.2	V

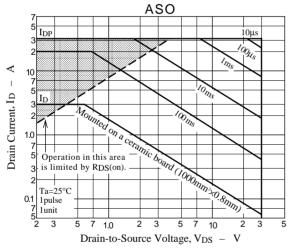
Switching Time Test Circuit

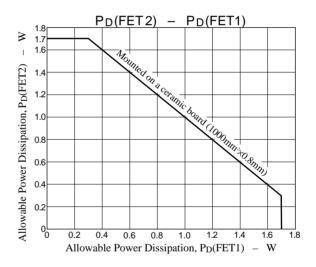
Electrical Connection

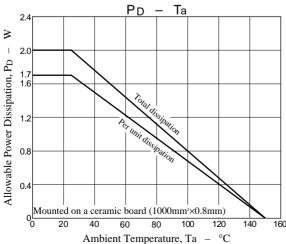
(Top view)











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